







TPS56837H, TPS56837HA SLVSHH7A - JANUARY 2024 - REVISED JUNE 2024

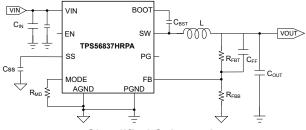
# TPS56837Hx 4.5V to 28V Input, 8A, Synchronous Buck Converter

### 1 Features

- Support for USB power delivery (USB PD)
  - 4.5V to 28V input voltage range
  - 4V to 22V output voltage range
  - Supports 8A continuous output current
  - Three adjustable cycle-by-cycle over current limit for low-side MOSFET by mode selection
- High efficiency over entire load range
  - Integrated 20.4mΩ and 9.5mΩ MOSFETs
  - 45uA low quiescent current
  - Fixed 500kHz switching frequency
  - 98.7% efficiency at  $V_{IN}$  = 24V,  $V_{OUT}$  = 20V and  $I_{OUT} = 3A$
  - Eco-mode for high light-load efficiency
- 0.6V ±1% reference voltage at 25°C
- D-CAP3<sup>™</sup> control mode for fast transient response
- Adjustable soft-start time by SS capacitor
- TPS56837H supports output discharge function
- Power-good indicator to monitor output voltage
- Supports up to 98% duty operation
- Non-latched protections for UV, OV, OT, and UVLO
- -40°C to +150°C operating junction temperature
- Small 10-pin 3.0mm × 3.0mm HotRod™QFN Package
- Pin-to-pin compatible with 6A TPS56637 and 8A **TPS56837**

# 2 Applications

- **USB Power Supplies with PD**
- Industrial PC, EPOS, factory automation and control
- Multifunction printers, video conference system
- Monitors, TV, speakers, PC and notebooks, portable electronics
- General purposes for 12V,19V, 24V power-bus supply



Simplified Schematic

## 3 Description

The TPS56837H and TPS56837HA are highefficiency, easy-to-use, synchronous buck converters with wide input voltage range of 4.5V to 28V. The devices support up to 8A continuous output current at output voltages between 4V and 22V, and support 5V, 9V, 15V, 20V dynamic output change for USB Power Delivery (USB PD) application.

The TPS56837H and TPS56837HA use D-CAP3 control mode to provide fast transient response, good line and load regulation, no requirement for external compensation, and support low equivalent series resistance (ESR) output capacitors like MLCC.

The TPS56837H and TPS56837HA operate at Ecomode to attain high efficiency at light load with fixed 500kHz switching frequency and three selectable current limit through MODE pin configuration. The TPS56837H and TPS56837HA have adjustable softstart time by the SS pin capacitor configuration.

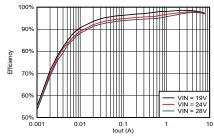
The TPS56837H and TPS56837HA provide complete non-latched OV, UV, OC, OT, and UVLO protections combined with power-good indicator features. TPS56837H supports output discharge function and TPS56837HA disables the function.

The TPS56837H and TPS56837HA are available in a 10-pin, 3.0mm × 3.0mm, HotRod QFN package, and the junction temperature is specified from -40°C to 150°C.

#### **Device Information**

PART NUMBER	OUTPUT DISCHARGE	PACKAGE <sup>(1)</sup>	PACKAGE SIZE <sup>(2)</sup>
TPS56837H	Enable	RPA (VQFN-	3.00mm ×
TPS56837HA	Disable	HR, 10)	3.00mm

- (1) For more information, see Section 10.
- The package size (length × width) is a nominal value and includes pins, where applicable.



Efficiency, Vout = 15V, Fsw = 500kHz



# **Table of Contents**

1 Features	1	7 Application and Implementation	17
2 Applications	1	7.1 Application Information	17
3 Description	1	7.2 Typical Application	17
4 Pin Configuration and Functions		7.3 Power Supply Recommendations	
5 Specifications	4	7.4 Layout	
5.1 Absolute Maximum Ratings		8 Device and Documentation Support	
5.2 ESD Ratings		8.1 Documentation Support	
5.3 Recommended Operating Conditions		8.2 Receiving Notification of Documentation Updates.	24
5.4 Thermal Information		8.3 Support Resources	
5.5 Electrical Characteristics	5	8.4 Trademarks	24
5.6 Typical Characteristics	8	8.5 Electrostatic Discharge Caution	24
6 Detailed Description		8.6 Glossary	24
6.1 Overview		9 Revision History	
6.2 Functional Block Diagram	12	10 Mechanical, Packaging, and Orderable	
6.3 Feature Description		Information	24
6.4 Device Functional Modes	16	10.1 Tape and Reel Information	25
		·	



# **4 Pin Configuration and Functions**

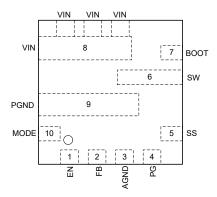


Figure 4-1. RPA Package, 10-Pin VQFN-HR (Top View)

**Table 4-1. Pin Functions** 

PIN	PIN		PIN TYPE <sup>(1)</sup>		DESCRIPTION
NAME	NO.	1166/	DESCRIPTION		
EN	1	1	Enable input control. Driving EN high or leaving this pin floating enables the converter. A resistor divider can be used to implement an UVLO function.		
FB	2	I	Output feedback. Connect FB to the output voltage with a feedback resistor divider.		
AGND	3	G	Ground of internal analog circuitry. Connect AGND to PGND plane at a single point.		
PG	4	0	Open drain power-good indicator,this pin is asserted low if output voltage is out of PG threshold due to overvoltage, undervoltage, thermal shutdown, EN shutdown, or during soft start.		
SS	5	0	Soft-start time selection pin. Connecting an external capacitor to AGND to set the soft-start time. A minimum 22nF ceramic capacitor must be connected at this pin, which sets the minimum soft-start time to approximately 2.2ms. Do not float.		
SW	6	0	Switching node terminal. Connect the output inductor to this pin with wide and short tracks.		
воот	7	1	Supply input for the gate drive voltage of the high-side MOSFET. Connect a 0.1µF bootstrap capacitor between BOOT and SW.		
VIN	8	Р	Input voltage supply pin. Drain terminal of high-side MOSFET. Connect the input decoupling capacitors between VIN and PGND.		
PGND	9	G	Power GND terminal. Source terminal of low-side MOSFET.		
MODE	10	ı	Current limit selection pin. Connect this pin with a resistor to AGND for different MODE options shown in Table 6-1.		

<sup>(1)</sup> I = Input, P = Power, G = Ground, O = Output.



# **5 Specifications**

# 5.1 Absolute Maximum Ratings

Over the recommended operating junction temperature range of -40°C to +150°C (unless otherwise noted)(1)

		MIN	MAX	UNIT
	V <sub>IN</sub>	-0.3	32	V
	воот	-0.3	SW + 6	V
Input voltage	BOOT-SW	-0.3	6	V
	EN, FB, MODE	-0.3	6	V
	PGND, AGND	-0.3	0.3	V
	SW	-2	32	V
Output voltage	SW (<10ns transient)	-5	35	V
	PG, SS	-0.3	6	V
Operating junction temperature, T <sub>J</sub>		-40	150	°C
Storage temperatu	ire, T <sub>stg</sub>	-65	150	°C

<sup>(1)</sup> Operation outside the Absolute Maximum Ratings may cause permanent device damage. Absolute Maximum Ratings do not imply functional operation of the device at these or any other conditions beyond those listed under Recommended Operating Conditions. If used outside the Recommended Operating Conditions but within the Absolute Maximum Ratings, the device may not be fully functional, and this may affect device reliability, functionality, performance, and shorten the device lifetime.

# 5.2 ESD Ratings

				VALUE	UNIT
	/	Electrostatic	Human body model (HBM), per ANSI/ESDA/JEDEC JS-001 <sup>(1)</sup>	±2000	V
`	/ <sub>ESD</sub>	discharge	Charged device model (CDM), per ANSI/ESDA/JEDEC JS-002 <sup>(2)</sup>	±500	·

- (1) JEDEC document JEP155 states that 500V HBM allows safe manufacturing with a standard ESD control process.
- (2) JEDEC document JEP157 states that 250V CDM allows safe manufacturing with a standard ESD control process.

# **5.3 Recommended Operating Conditions**

Over the recommended operating junction temperature range of -40°C to 150°C (unless otherwise noted).(1)

	. 37	MIN	NOM MAX	UNIT
	V <sub>IN</sub>	4.5	28	V
	BOOT	-0.1	SW + 5.5	
Input voltage	BOOT-SW	-0.1	5.5	V
	EN, FB, SS, MODE	-0.1	5.5	V
	PGND, AGND	-0.1	0.1	V
Output voltage	SW	-1	28	V
Output voltage	PG	-0.1	5.5	V
Operating junction	on temperature, T <sub>J</sub>	-40	150	°C

Product Folder Links: TPS56837H TPS56837HA



### **5.4 Thermal Information**

		Device	
	THERMAL METRIC <sup>(1)</sup>	QFN HotRod	UNIT
		10 PINS	
$R_{\theta JA}$	Junction-to-ambient thermal resistance (JEDEC) <sup>(2)</sup>	68.1	°C/W
Eff R <sub>0JA</sub>	Effective junction-to-ambient thermal resistance (4-layer TI EVM)	30	°C/W
$R_{\theta JC(top)}$	Junction-to-case (top) thermal resistance	40.4	°C/W
$R_{\theta JB}$	Junction-to-board thermal resistance	17.6	°C/W
$\Psi_{JT}$	Junction-to-top characterization parameter	1.4	°C/W
$\Psi_{JB}$	Junction-to-board characterization parameter	17.2	°C/W

For more information about traditional and new thermal metrics, see the Semiconductor and IC Package Thermal Metrics application report.

### 5.5 Electrical Characteristics

The electrical ratings specified in this section apply to all specifications in this document unless otherwise noted. These specifications are interpreted as conditions that do not degrade the parametric or functional specifications of the device for the life of the product containing it. Typical values correspond to  $T_J = 25^{\circ}C$ ,  $V_{IN} = 24V$ . Minimum and maximum limits are based on  $T_{J} = -40^{\circ}C$  to  $+150^{\circ}C$ ,  $V_{IN} = 4.5V$  to 28V (unless otherwise noted).

P	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
SUPPLY CURR	ENT					
IQ	Quiescent current Operating <sup>(1)</sup>	$T_J = 25$ °C, $V_{EN} = 5$ V, $V_{FB} = 0.65$ V, non-switching		45		μΑ
I <sub>SHDNN</sub>	Shutdown supply current	T <sub>J</sub> = 25°C, V <sub>EN</sub> = 0V		3		μΑ
UVLO						
		Wake up V <sub>IN</sub> voltage	4.0	4.2	4.4	V
UVLO	V <sub>IN</sub> undervoltage lockout	Shutdown V <sub>IN</sub> voltage	3.5	3.65	3.8	V
		Hysteresis V <sub>IN</sub> voltage		550		mV
ENABLE(EN PI	N)					
I <sub>EN_PULLUP</sub>	EN pullup current	V <sub>EN</sub> = 1.1V		1		μΑ
I <sub>EN_HYS</sub>	Hysteresis current	V <sub>EN</sub> = 1.3V		3		μΑ
V <sub>EN_ON</sub>	Enable three-bald	EN rising		1.18	1.26	V
V <sub>EN_OFF</sub>	Enable threshold	EN falling	1	1.07		V
FEEDBACK VO	DLTAGE				'	
V	Feedback voltage	V <sub>OUT</sub> = 5V, continuous mode operation, T <sub>J</sub> = 25°C	0.594	0.6	0.606	V
$V_{FB}$	reedback voltage	V <sub>OUT</sub> = 5V, continuous mode operation, T <sub>J</sub> = -40°C to 150°C	0.591	0.6	0.609	V
MOSFET					-	
R <sub>dson_HS</sub>	High-side MOSFET on-resistance	T <sub>J</sub> = 25°C, V <sub>BST</sub> – V <sub>SW</sub> = 5V		20.4		mΩ
R <sub>dson_LS</sub>	Low-side MOSFET on-resistance	T <sub>J</sub> = 25°C		9.5		mΩ

Copyright © 2024 Texas Instruments Incorporated

Submit Document Feedback

<sup>(2)</sup> This junction-to-ambient thermal resistance (JEDEC) is based on JEDEC standard EVM without GND thermal vias.



### 5.5 Electrical Characteristics (continued)

The electrical ratings specified in this section apply to all specifications in this document unless otherwise noted. These specifications are interpreted as conditions that do not degrade the parametric or functional specifications of the device for the life of the product containing it. Typical values correspond to  $T_J = 25^{\circ}C$ ,  $V_{IN} = 24V$ . Minimum and maximum limits are based on  $T_J = -40^{\circ}C$  to  $+150^{\circ}C$ ,  $V_{IN} = 4.5V$  to 28V (unless otherwise noted).

P	ARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
CURRENT LIMI	Т					
		ILIM-1 option	6	7.2	8.5	
I <sub>LS_OCL</sub>	Low-side MOSFET valley current limit	ILIM option	8	9.6	11.1	Α
	valicy current limit	ILIM+1 option	10	12	13.8	
I <sub>HS_OCL</sub>	High-side MOSFET peak current limit		12.75	15	17.25	Α
NOCL	Low-side MOSFET negative current limit		2.5			Α
DUTY CYCLE a	nd FREQUENCY CONTRO	L				
F <sub>SW</sub>	Switching frequency	V <sub>IN</sub> = 24V, V <sub>OUT</sub> = 5V, continuous mode operation		500		kHz
t <sub>ON(MIN)</sub>	Minimum on time <sup>(2)</sup>			50		ns
t <sub>OFF(MIN)</sub>	Minimum off time <sup>(2)</sup>			200		ns
SOFT START						
I <sub>SS</sub>	Soft-start charging current			6		uA
POWER GOOD						
	PG lower threshold - falling	% of V <sub>FB</sub>		85%		
	PG lower threshold - rising	% of V <sub>FB</sub>		90%		
$V_{PGTH}$	PG upper threshold - falling	% of V <sub>FB</sub>		110%		
	PG upper threshold - rising	% of V <sub>FB</sub>		115%		
I <sub>PGSINK</sub>	PG sink current	V <sub>FB</sub> = 0.5V, V <sub>PG</sub> = 0.4V	10			mA
<b>!</b>	PG delay	PG from low-to-high		64		us
t <sub>PG_DLY</sub>	1 O delay	PG from high-to-low		32		us
$V_{OVP}$	Output OVP threshold	OVP detect		125%		
OVP_DEG	OVP propagation deglitch	T <sub>J</sub> = 25°C		32		us
V <sub>UVP</sub>	Output UVP threshold	Hiccup detect		65%		
UVP_WAIT	UV protection hiccup wait time			256		us
tuvp_HICCUP	UV protection hiccup time before recovery		1	0.5 × t <sub>ss</sub>		s
THERMAL SHU	TDOWN		1		L	
Thormal abutation	un throphold(3)	Temperature Rising	150	165		°C
Thermal shutdown threshold <sup>(3)</sup>		Hysteresis		30		°C

Product Folder Links: TPS56837H TPS56837HA



# 5.5 Electrical Characteristics (continued)

The electrical ratings specified in this section apply to all specifications in this document unless otherwise noted. These specifications are interpreted as conditions that do not degrade the parametric or functional specifications of the device for the life of the product containing it. Typical values correspond to  $T_J = 25^{\circ}C$ ,  $V_{IN} = 24V$ . Minimum and maximum limits are based on  $T_J = -40^{\circ}C$  to  $+150^{\circ}C$ ,  $V_{IN} = 4.5V$  to 28V (unless otherwise noted).

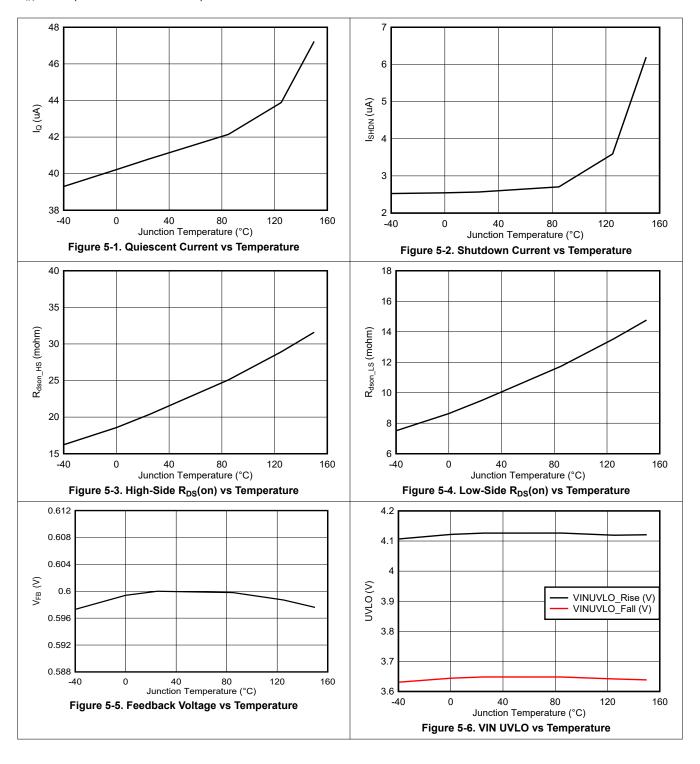
PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
V <sub>OUT</sub> discharge resistance (Only for TPS56837H)	V <sub>EN</sub> = 0, V <sub>SW</sub> = 0.5V, T <sub>J</sub> = 25°C		200		Ω

- (1) Not representative of the total input current of the system when in regulation. Specified by design and characterization test.
- (2) Not production tested. Specified by design.
- (3) Not production tested. Specified by design and engineering sample correlation.



# **5.6 Typical Characteristics**

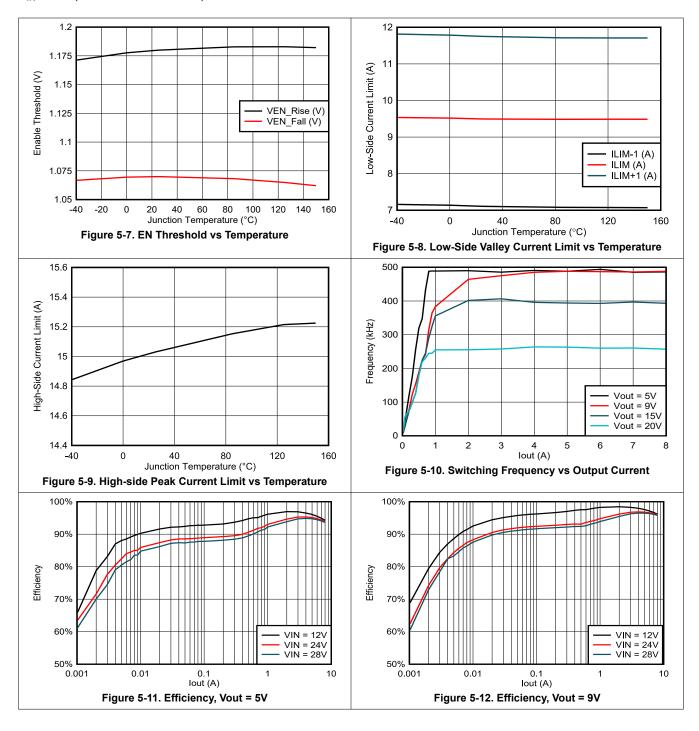
V<sub>IN</sub> = 24V (unless otherwise noted).





# 5.6 Typical Characteristics (continued)

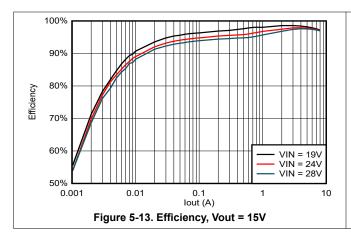
V<sub>IN</sub> = 24V (unless otherwise noted).

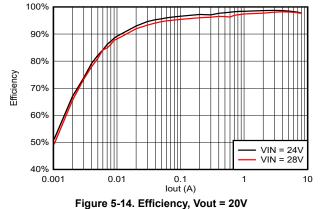




# **5.6 Typical Characteristics (continued)**

 $V_{IN}$  = 24V (unless otherwise noted).







# 6 Detailed Description

### 6.1 Overview

The TPS56837H and TPS56837HA are 8A synchronous buck converters operating from 4.5V to 28V input voltage (Vin). The devices output voltage range from 4V to 22V (Vout) and support 5V, 9V, 15V, 20V dynamic change for USB Power Delivery (USB PD) application.

The proprietary D-CAP3 control mode enables low external component count, ease of design, optimization of the power design for power, size and efficiency. The devices employ D-CAP3 control mode that provides fast transient response with no external compensation components and an accurate feedback voltage. The control topology provides seamless transition between CCM operating mode at higher load condition and DCM operation at lighter load condition. Eco-mode allows the TPS56837H and TPS56837HA to maintain high efficiency at light load. The TPS56837H and TPS56837HA are able to adapt both low equivalent series resistance (ESR) output capacitors such as POSCAP or SP-CAP, and ultra-low ESR ceramic capacitors.

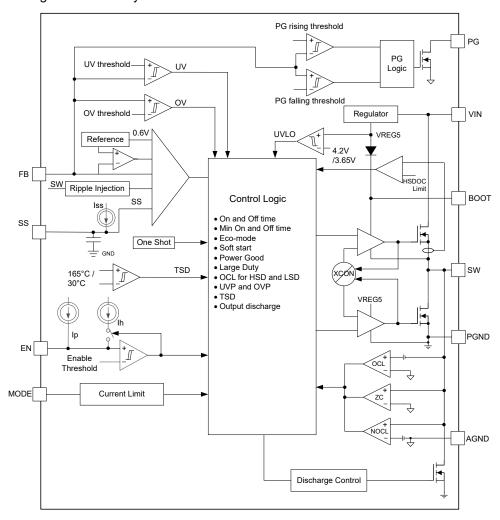
The TPS56837H and TPS56837HA switching frequencies (Fsw) are fixed 500kHz. There are three selectable current limits (ILIM-1, ILIM, ILIM+1). All of these options are configured by connecting right MODE resistor between MODE and AGND pin.

The EN pin has an internal pullup current that can be used to adjust the input voltage undervoltage lockout (UVLO) with two external resistors. In addition, the EN pin can be floating for the device to operate with the internal pullup current. Soft-start time can be set by connecting a capacitor to the SS pin. Do not leave the SS pin floating. The TPS56837H and TPS56837HA have PG pin to indicate output status. TPS56837H has a built-in discharge function by using an integrated MOSFET with  $200\Omega~R_{\rm DS(on)}$  and TPS56837HA disables output discharge function. The devices are protected from output short, undervoltage, overvoltage and overtemperature conditions.



### 6.2 Functional Block Diagram

Note: Output discharge control is only enabled in TPS56837H and disabled in TPS56837HA.



### **6.3 Feature Description**

### 6.3.1 The Adaptive On-Time Control and PWM Operation

The main control loop of the TPS56837H and TPS56837HA is adaptive on-time pulse width modulation (PWM) controller that supports a proprietary D-CAP3 control mode. The D-CAP3 control mode combines adaptive on-time control with an internal compensation circuit for quasi-fixed frequency and low external component count configuration with both low-ESR and ceramic output capacitors. The D-CAP3 control mode is stable even with virtually no ripple at the output. The TPS56837H and TPS56837HA also include error amplifier that makes the output voltage very accurate. No external current sense network or loop compensation is required for D-CAP3 control mode topology.

At the beginning of each cycle, the high-side MOSFET is turned on. This MOSFET is turned off after internal one-shot timer expires. This one-shot duration is set proportional to the output voltage  $V_{OUT}$ , and is inversely proportional to the converter input voltage  $V_{IN}$ , to maintain a pseudo-fixed frequency over the input voltage range, hence called adaptive on-time control. When the feedback voltage falls below the reference voltage, the one-shot timer is reset and the high-side MOSFET is turned on again. An internal ripple generation circuit is added to reference voltage for emulating the output ripple, and this enables the use of very low-ESR output capacitors such as multi-layered ceramic caps (MLCC).

Product Folder Links: TPS56837H TPS56837HA

#### 6.3.2 Mode Selection

TPS56837H and TPS56837HA have MODE pin that can offer three adjustable cycle-by-cycle over current limit for low-side MOSFET. The device reads the voltage on the MODE pin during start-up and latches onto one of the MODE options listed in Table 6-1. The voltage on the MODE pin can be set by connecting a resistor to AGND. A guideline for the MODE resistor in 1% resistors is shown in Table 6-1. The MODE pin setting can be reset only by a VIN or EN power cycling.

**Table 6-1. MODE Pin Settings** 

MODE Pin	Over Current Limit	
R = 10kohm	ILIM-1 (Typ = 7.2A)	
R = 30.1kohm	ILIM (Typ = 9.6A)	
R = 52.3kohm	ILIM+1 (Typ = 12A)	

Figure 6-1 shows the typical start-up sequence of the device after the enable signal triggers the EN turn-on threshold. After the voltage of internal VCC crosses the UVLO rising threshold, the MODE setting is read. After this process, the MODE is latched and does not change until VIN or EN toggles to restart this device. Then, after a delay, the internal soft-start function begins to ramp up and Vout ramps up smoothly. When Vout is up to the reference voltage, PGOOD turns to high after a delay.

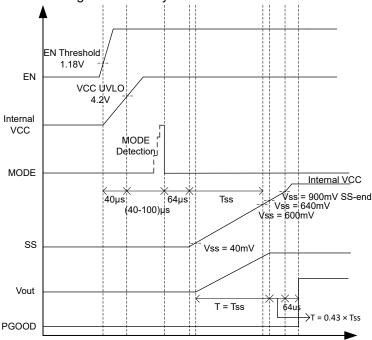


Figure 6-1. Power-Up Sequence

### 6.3.3 Eco-mode Control Scheme

TPS56837H and TPS56837HA are set to Eco-mode control scheme to maintain high light load efficiency. As the output current decreases from heavy load condition, the inductor current is also reduced and eventually comes to a point that the rippled valley touches zero level, which is the boundary between continuous conduction and discontinuous conduction modes. The rectifying MOSFET is turned off when the zero inductor current is detected. As the load current further decreases the converter runs into discontinuous conduction mode. The on-time is kept almost the same as in the continuous conduction mode so that longer time is needed to discharge the output capacitor with smaller load current to the level of the reference voltage. This process makes the switching frequency lower, proportional to the load current, and keeps the light load efficiency high. Use Equation 1 to calculate the transition point to the light load operation I<sub>OUT(LL)</sub>.



$$I_{OUT(LL)} = \frac{1}{2 \times L \times Fsw} \times \frac{(V_{IN} - V_{OUT}) \times V_{OUT}}{V_{IN}}$$
(1)

#### 6.3.4 Soft Start and Prebiased Soft Start

The TPS56837H and TPS56837HA have adjustable soft-start time that can be set by connecting a capacitor between SS and AGND. When the EN pin becomes high, the soft-start charge current ( $I_{SS}$ ) begins charging the external capacitor ( $C_{SS}$ ) connected between SS and AGND. Equation 2 shows the equation for the soft-start time ( $I_{SS}$ ).

$$T_{ss} = \frac{C_{ss} \times V_{REF}}{I_{ss}}$$
 (2)

If the external capacitor (C<sub>SS</sub>) has pre-stored voltage at start-up, the device initially discharge the external capacitor voltage to lower voltage then charge again to prevent inrush start-up.

If the output capacitor is prebiased at start-up, the device initiates switching and starts ramping up only after the internal reference voltage becomes greater than the feedback voltage  $V_{FB}$ . This scheme makes sure that the converters ramp up smoothly into regulation point.

### 6.3.5 Enable and Adjusting Undervoltage Lockout

The EN pin provides electrical on and off control of the device. When the EN pin voltage exceeds the threshold voltage, the device begins operating. If the EN pin voltage is pulled below the threshold voltage, the regulator stops switching and enters the standby operation.

The EN pin has an internal pullup current source which allows the user to float the EN pin to enable the device. If an application requires control of the EN pin, open-drain or open-collector output logic can be used to interface with the pin.

The TPS56837H and TPS56837HA implement internal undervoltage lockout (UVLO) circuitry on the  $V_{IN}$  pin. The device is disabled when the VIN pin voltage falls below the internal  $V_{IN}$  UVLO threshold. The internal  $V_{IN}$  UVLO threshold has a hysteresis of 500mV.

If an application requires a higher UVLO threshold on the VIN pin, then the EN pin can be configured as shown in Figure 6-2. When using the external UVLO function, TI recommends setting the hysteresis at a value greater than 500mV.

The EN pin has a small pullup current,  $I_p$ , which sets the default state of the pin to enable when no external components are connected. The pullup current is also used to control the voltage hysteresis for the UVLO function because the pullup current increases by  $I_h$  when the EN pin crosses the enable threshold. Use Equation 3, and Equation 4 to calculate the values of R1 and R2 for a specified UVLO threshold. After R1, R2 settle down, the  $V_{EN}$  voltage can be calculated by Equation 5, which must be lower than 5.5V with maximum  $V_{EN}$ .

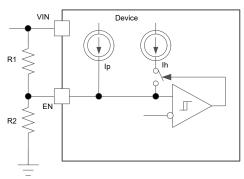


Figure 6-2. Adjustable VIN Undervoltage Lockout

Submit Document Feedback

Copyright © 2024 Texas Instruments Incorporated



$$R_{1} = \frac{V_{START} \times \frac{V_{ENfalling}}{V_{ENrising}} - V_{STOP}}{I_{p} \times \left(1 - \frac{V_{ENfalling}}{V_{ENrising}}\right) + I_{h}}$$
(3)

$$R_{2} = \frac{R_{1} \times V_{\text{ENfalling}}}{V_{\text{STOP}} - V_{\text{ENfalling}} + R_{1} \times (I_{p} + I_{h})}$$

$$\tag{4}$$

$$V_{EN} = \frac{R_2 \times V_{IN} + R_1 \times R_2 \times (I_p + I_h)}{R_1 + R_2}$$
 (5)

### Where

- I<sub>D</sub> = 1µA
- $I_h = 3\mu A$
- V<sub>ENfalling</sub> = 1.07V
- V<sub>ENrising</sub> = 1.18V

### 6.3.6 Output Overcurrent Limit and Undervoltage Protection

The output overcurrent protection (OCP) is implemented using a cycle-by-cycle low-side MOSFET valley current detection and high-side MOSFET peak current detection. The switching current is monitored by measuring the MOSFET drain to source voltage. This voltage is proportional to the switching current. To improve accuracy, the voltage sensing is temperature compensated.

There are some important considerations for this type of overcurrent limit. When the load current is higher than the  $I_{LS\_OCL}$  added by one half of the peak-to-peak inductor ripple current, or higher than  $I_{HS\_OCL}$  subtracted by one half of the peak-to-peak inductor ripple current, the OCP is triggered and the current is limited. Output voltage tends to drop because the load demand is higher than what the converter can support. When the output voltage falls below 65% of the target voltage, the UVP comparator detects this fall and shuts down the device after a deglitch wait time of 256us and then re-starts after the hiccup time of 10.5 cycles of soft-start time. When the overcurrent condition is removed, the output recovers.

#### 6.3.7 Overvoltage Protection

The TPS56837H and TPS56837HA have the overvoltage protection feature. When the output voltage becomes higher than 125% of the target voltage, the OVP is triggered. Both the high-side MOSFET driver and the low-side MOSFET driver turn off. For TPS56837H, the output discharges after a deglitch time of 32us. When the overvoltage condition is removed, the output voltage recovers.

### 6.3.8 UVLO Protection

Undervoltage Lockout protection(UVLO) monitors the internal regulator voltage. When the voltage is lower than UVLO threshold voltage, the device is shut down. This protection is non-latched.

#### 6.3.9 Thermal Shutdown

The junction temperature  $(T_J)$  of the device is monitored by an internal temperature sensor. If  $T_J$  exceeds 165°C (typical), the device goes into thermal shutdown. Both the high-side and low-side power FETs are turned off. For TPS56837H, the discharge path is turned on. When  $T_J$  decreases below the hysteresis amount, the converter resumes normal operation, beginning with soft start. To avoid unstable conditions, a hysteresis of typically 30°C is implemented on the thermal shutdown temperature.

### 6.3.10 Output Voltage Discharge

The TPS56837H has a built-in discharge function by using an integrated MOSFET with  $200\Omega$  R<sub>DS(on)</sub>, which is connected to the output terminal SW. The discharge is slow due to the lower current capability of the MOSFET. The discharge path turns on when the device is turned off due to UV, OV, OT, and EN shutdown conditions. TPS56837HA disables this function.

#### 6.3.11 Power Good

The TPS56837H and TPS56837HA have built-in power-good (PG) function to indicate whether the output voltage has reached the appropriate level or not. The PG signal can be used for start-up sequencing of multiple rails. The PG pin is an open-drain output that requires a pullup resistor (to any voltage below 5.5V). TI recommends a pullup resistor of  $100k\Omega$  to pull up to 5V voltage. The PG pin can sink 10mA of current and maintain the specified logic low level. After the FB pin voltage is between 90% and 110% of the internal reference voltage ( $V_{REF}$ ) and after a deglitch time of  $64\mu s$ , the PG turns to high impedance status. The PG pin is pulled low after a deglitch time of  $32\mu s$  when FB pin voltage is lower than 85% of the internal reference voltage or greater than 115% of the internal reference voltage, or in events of EN shutdown, UVLO conditions, and thermal shutdown.  $V_{IN}$  must remain present for the PG pin to stay low as shown in Table 6-2.

Table 6-2. Power-Good Pin Logic Table

Do	viae State	PG Logi	c Status
Device State		High Impedance	Low
Enable (EN = High)	90% × V <sub>REF</sub> =< V <sub>FB</sub> <= 110% × V <sub>REF</sub>	V	
Lilable (Liv – High)	$V_{FB}$ < 85% × $V_{REF}$ or $V_{FB}$ > 115% × $V_{REF}$		V
Shutdown (EN = Low)			V
UVLO	2V < V <sub>IN</sub> < V <sub>UVLO</sub>		√
Thermal shutdown	T <sub>J</sub> > T <sub>SD</sub>		√
Power supply removal	V <sub>IN</sub> < 2V	V	

### 6.3.12 Large Duty Operation

The TPS56837H and TPS56837HA can support large duty operations by smoothly dropping down the switching frequency. The switching frequency is allowed to smoothly drop when duty cycle is higher than 62% to make  $T_{ON}$  extended to implement the large duty operation and also improve the performance of the load transient. The TPS56837HA can support up to 98% duty cycle operation.

### 6.4 Device Functional Modes

### 6.4.1 Standby Operation

The TPS56837H and TPS56837HA can be placed in standby mode by pulling the EN pin low. The device operates with a shutdown current of  $3\mu$ A (typical) when in standby condition.

## 6.4.2 Light Load Operation

TPS56837H and TPS56837HA are set to Eco-mode control scheme. The device enters pulse skip mode after the valley of the inductor ripple current crosses zero. The Eco-mode control scheme maintains higher efficiency at light load with a lower switching frequency.

Submit Document Feedback



# 7 Application and Implementation

### **Note**

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes, as well as validating and testing their design implementation to confirm system functionality.

## 7.1 Application Information

The schematic of Figure 7-1 shows a typical application for TPS56837H. This design converts an input voltage range of 16V to 28V down to 15V with a maximum output current of 8A.

The same typical application can be used for TPS56837HA.

# 7.2 Typical Application

The application schematic in Figure 7-1 shows the TPS56837H 16V to 28V input, 15V output converter design meeting the requirements for 8A output. This circuit is available as the evaluation module (EVM). The following sections provide the design procedure.

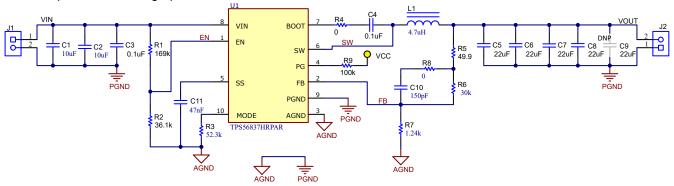


Figure 7-1. TPS56837H 15V, 8A Reference Design

### 7.2.1 Design Requirements

Table 7-1 shows the design parameters for this application.

Table 7-1. Design Parameters

PARAMETER	EXAMPLE VALUE
Input voltage range	24V nominal, 16V to 28V
Output voltage	15V
Transient response, 8A load step	$\Delta V_{OUT} = \pm 5\%$
Output ripple voltage	80mV at CCM
Output current rating	8A
Operating frequency	500kHz

### 7.2.2 Detailed Design Procedure

### 7.2.2.1 Output Voltage Resistors Selection

The output voltage is set with a resistor divider from the output node to the VFB pin. TI recommends to use 1% tolerance or better divider resistors. Start by using Equation 6 to calculate VOUT. R5 is optional and can be used to measure the control loop frequency response.

To improve efficiency at very light loads, consider using larger value resistors. If the resistance is too high, the device is more susceptible to noise and the voltage errors from the VFB input current is more noticeable.

$$V_{OUT} = 0.6 \times \left(1 + \frac{R6}{R7}\right) \tag{6}$$

### 7.2.2.2 Output Filter Selection

The LC filter used as the output filter has double pole at:

$$f_{p} = \frac{1}{2\pi \times \sqrt{L_{\text{OUT}} \times C_{\text{OUT}}}} \tag{7}$$

At low frequencies, the overall loop gain is set by the output set-point resistor divider network and the internal gain of the device. The low frequency phase is 180 degrees. At the output filter pole frequency, the gain rolls off at a –40dB per decade rate and the phase drops rapidly. D-CAP3 control mode introduces a high frequency zero that reduces the gain roll off to –20dB per decade and increases the phase to 90 degrees one decade above the zero frequency. The inductor and capacitor for the output filter must be selected so that the double pole of Equation 7 is located below the high frequency zero but close enough that the phase boost provided be the high frequency zero provides adequate phase margin for a stable circuit. To meet this requirement use the values recommended in Table 7-2.

C<sub>OUT</sub> (2) (µF) **Switching** Output R<sub>6</sub> R7 Frequency L1 (µH) C10 (3)(pF) Voltage<sup>(1)</sup> (V)  $(k\Omega)$  $(k\Omega)$ **Typical** Maximum (kHz) 5 30 4.1 22uF × 4 22uF × 10 150 9 30 2.15 4.7 22uF × 4 22uF × 10 150 500 15 30 1.24 47 22uF × 4 22uF x 10 150 22uF × 4 4.7 22uF × 10 150

**Table 7-2. Recommended Component Values** 

- Please use the recommended L1 and C<sub>OUT</sub> combination of the higher and closest output rail for unlisted output rails.
- (2) C<sub>OUT</sub> in this data sheet is using TDK C3216X5R1V226M160AC 35VDC capacitor. TI recommends to use the same effective output capacitance. The effective capacitance is defined as the actual capacitance under DC bias and temperature, not the rated or nameplate values. All high value ceramic capacitors have a large voltage coefficient in addition to normal tolerances and temperature effects. A careful study of bias and temperature variation of any capacitor bank must be made to make sure that the minimum value of effective capacitance is provided. Refer to the information of DC bias and temperature characteristics from manufacturers of ceramic capacitors. Higher than Cout max capacitance is allowed by careful tuning the feedforward compensation.
- (3) C10 can be used to improve the load transient response or improve the loop-phase margin. The Optimizing Transient Response of Internally Compensated DCDC Converters with Feed-forward Capacitor application report is helpful when experimenting with a feed-forward capacitor.

Calculate the inductor peak-to-peak ripple current, peak current and RMS current using Equation 8, Equation 9, and Equation 10. The inductor saturation current rating must be greater than the calculated peak current and the RMS or heating current rating must be greater than the calculated RMS current.

Use 500kHz for  $f_{SW}$ . Make sure the chosen inductor is rated for the peak current of Equation 9 and the RMS current of Equation 10.



$$Il_{p-p} = \frac{V_{OUT}}{V_{IN(MAX)}} \times \frac{V_{IN(MAX)} - V_{OUT}}{L_{OUT} \times F_{SW}}$$
(8)

$$Il_{PEAK} = I_O + \frac{Il_{p-p}}{2} \tag{9}$$

$$I_{LO(RMS)} = \sqrt{I_0^2 + \frac{1}{12} \times Il_{p-p}^2}$$
 (10)

The capacitor value and ESR determines the amount of output voltage ripple. The TPS56837H is intended for use with ceramic or other low ESR capacitors. Use Equation 11 to determine the required RMS current rating for the output capacitor.

$$I_{CO(RMS)} = \frac{V_{OUT} \times (V_{IN} - V_{OUT})}{\sqrt{12} \times V_{IN} \times L_{OUT} \times F_{SW}}$$
(11)

### 7.2.2.3 Input Capacitor Selection

The TPS56837H requires an input decoupling capacitor, and a bulk capacitor is needed depending on the application. TI recommends a ceramic capacitor over  $10\mu\text{F}$  for the decoupling capacitor. TI recommends an additional  $0.1\mu\text{F}$  capacitor (C3) from the VIN to the PGND pin to provide additional high frequency filtering. The capacitor voltage rating must be greater than the maximum input voltage. Calculate the input voltage ripple using Equation 12.

$$\Delta V_{\rm IN} = \frac{I_{\rm OUTMAX} \times 0.25}{C_{\rm IN} \times Fsw}$$
 (12)

The capacitor must also have a ripple current rating greater than the maximum input current ripple of the application. The input ripple current is calculated by Equation 13:

$$I_{CIN(RMS)} = I_{OUT} \times \sqrt{\frac{V_{OUT}}{V_{IN(MIN)}} \times \frac{V_{IN(MIN)} - V_{OUT}}{V_{IN(MIN)}}}$$
(13)

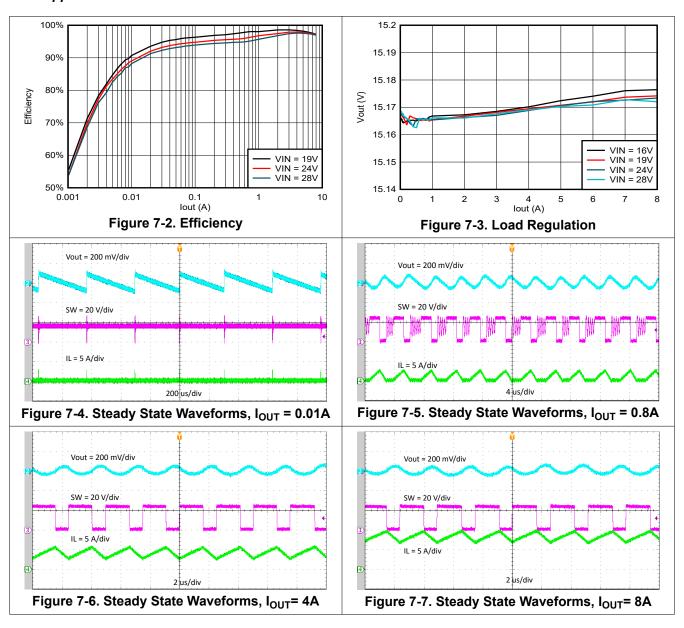
### 7.2.2.4 Bootstrap Capacitor Selection

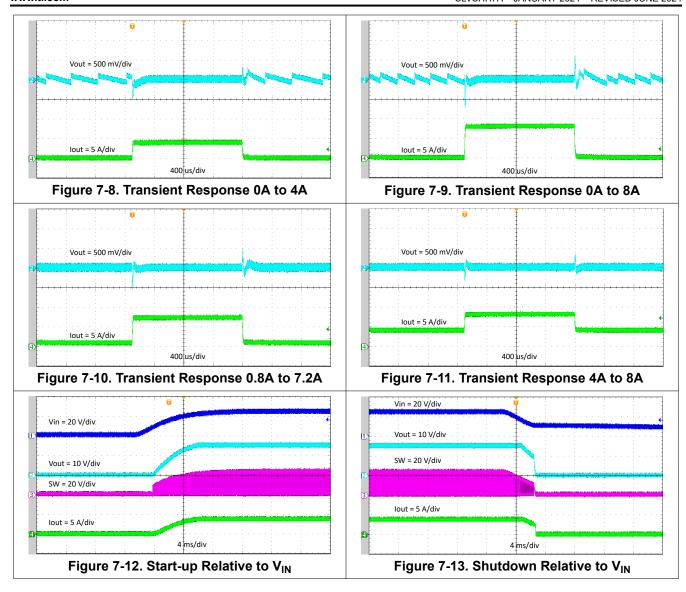
A 0.1µF ceramic capacitor (C4) must be connected between the BOOT to SW pin for proper operation. TI recommends to use a ceramic capacitor with X5R or better grade dielectric. The capacitor must have a 10V or higher voltage rating.

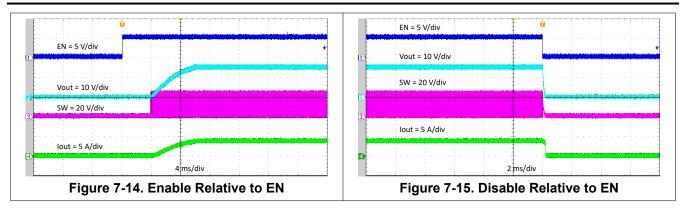
Copyright © 2024 Texas Instruments Incorporated



### 7.2.3 Application Curves







### 7.3 Power Supply Recommendations

The TPS56837H and TPS56837HA are designed to operate from input supply voltage in the range of 4.5V to 28V. Buck converters require the input voltage to be higher than the output voltage for proper operation. Input supply current must be appropriate for the desired output current. If the input voltage supply is located far from the TPS56837HA and TPS56837HA circuit, TI recommends some additional input bulk capacitance.

### 7.4 Layout

## 7.4.1 Layout Guidelines

- 1. Use a four-layer PCB with maximum ground plane partitioning possible for good thermal performance. A 76mm × 76mm, four-layer PCB with 2-1-1-2 oz copper is used as example.
- 2. Make VIN and PGND traces as wide as possible to reduce trace impedance. The wide areas are also of advantage from the view point of heat dissipation.
- 3. Put at least two vias for PGND pad for better thermal performance.
- 4. Place the input capacitor and output capacitor as close to the device as possible to minimize trace impedance.
- 5. Provide sufficient vias for the input capacitor and output capacitor.
- 6. Keep the SW trace as physically short and wide as practical to minimize radiated emissions.
- 7. Do not allow switching current to flow under the device.
- 8. Keep the SS trace as far as possible to SW trace to minimize coupling during soft start.
- 9. Connect a separate VOUT path to the upper feedback resistor.
- 10. Keep the voltage feedback loop away from the high-voltage switching trace, and preferably has ground shield.
- 11. Make the trace of the VFB node as small as possible to avoid noise coupling. Also keep feedback resistors and the feedforward capacitor near the IC.
- 12. Make the PGND trace between the output capacitor and the PGND pin as wide as possible to minimize the trace impedance.
- 13. Note that inner layer 1 is PGND and AGND with the single point net tie.
- 14. Note that inner layer 2 is PGND for better heat dissipation.

Submit Document Feedback

Copyright © 2024 Texas Instruments Incorporated



# 7.4.2 Layout Example

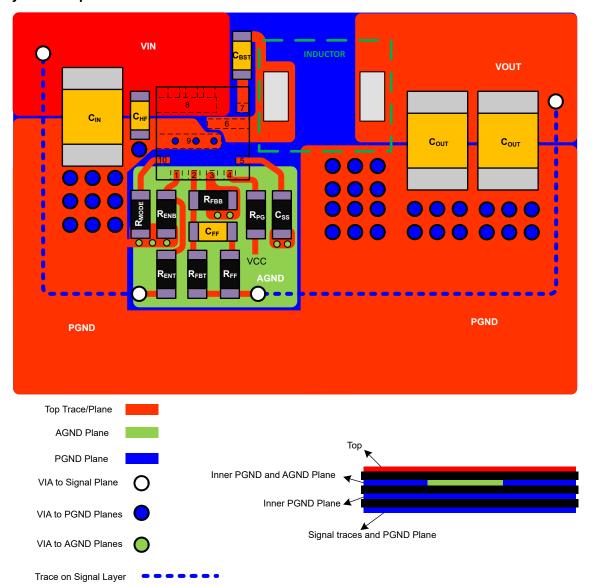


Figure 7-16. TPS56837H and TPS56837HA Layout

# 8 Device and Documentation Support

## 8.1 Documentation Support

#### 8.1.1 Related Documentation

For related documentation, see the following:

Texas Instruments, Optimizing Transient Response of Internally Compensated DCDC Converters with Feedforward Capacitor application report

# 8.2 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on ti.com. Click on *Notifications* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

### 8.3 Support Resources

TI E2E<sup>™</sup> support forums are an engineer's go-to source for fast, verified answers and design help — straight from the experts. Search existing answers or ask your own question to get the quick design help you need.

Linked content is provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's Terms of Use.

#### 8.4 Trademarks

D-CAP3<sup>™</sup>, HotRod<sup>™</sup>, and TI E2E<sup>™</sup> are trademarks of Texas Instruments. All trademarks are the property of their respective owners.

# 8.5 Electrostatic Discharge Caution



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

## 8.6 Glossary

TI Glossary

This glossary lists and explains terms, acronyms, and definitions.

### 9 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

### Changes from Revision \* (January 2024) to Revision A (June 2024)

Page

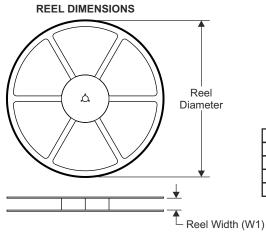
## 10 Mechanical, Packaging, and Orderable Information

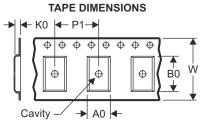
The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

Product Folder Links: TPS56837H TPS56837HA



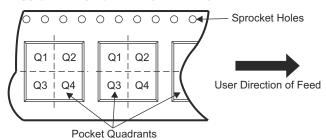
# 10.1 Tape and Reel Information





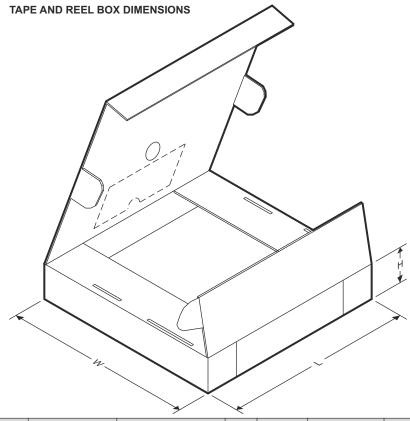
A0	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers
	,

### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TPS56837HRPAR	VQFN-HR	RPA	10	5000	330.0	12.4	3.3	3.3	1.1	8.0	12.0	Q2
TPS56837HARPAR	VQFN-HR	RPA	10	5000	330.0	12.4	3.3	3.3	1.1	8.0	12.0	Q2





Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TPS56837HRPAR	VQFN-HR	RPA	10	5000	367.0	367.0	35.0
TPS56837HARPAR	VQFN-HR	RPA	10	5000	367.0	367.0	35.0

Product Folder Links: TPS56837H TPS56837HA

www.ti.com 8-Nov-2025

### PACKAGING INFORMATION

Orderable part number	Status	Material type	Package   Pins	Package qty   Carrier	RoHS	Lead finish/	MSL rating/	Op temp (°C)	Part marking
	(1)	(2)			(3)	Ball material	Peak reflow		(6)
						(4)	(5)		
TPS56837HARPAR	Active	Production	VQFN-HR (RPA)   10	5000   LARGE T&R	Yes	SN	Level-2-260C-1 YEAR	-40 to 150	T837HA
TPS56837HARPAR.A	Active	Production	VQFN-HR (RPA)   10	5000   LARGE T&R	Yes	SN	Level-2-260C-1 YEAR	-40 to 150	T837HA
TPS56837HRPAR	Active	Production	VQFN-HR (RPA)   10	5000   LARGE T&R	Yes	SN	Level-2-260C-1 YEAR	-40 to 150	T6837H
TPS56837HRPAR.A	Active	Production	VQFN-HR (RPA)   10	5000   LARGE T&R	Yes	SN	Level-2-260C-1 YEAR	-40 to 150	T6837H

<sup>(1)</sup> Status: For more details on status, see our product life cycle.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

<sup>(2)</sup> Material type: When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

<sup>(4)</sup> Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

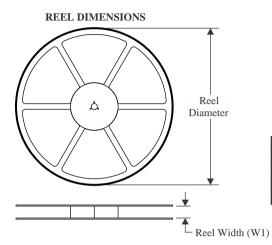
<sup>(5)</sup> MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

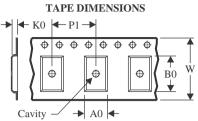
<sup>(6)</sup> Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

# **PACKAGE MATERIALS INFORMATION**

www.ti.com 25-Sep-2024

## TAPE AND REEL INFORMATION





A0	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE

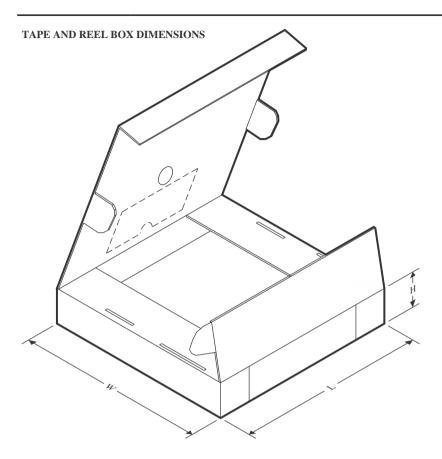


#### \*All dimensions are nominal

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	` ,	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TPS56837HARPAR	VQFN- HR	RPA	10	5000	330.0	12.4	3.3	3.3	1.1	8.0	12.0	Q2
TPS56837HRPAR	VQFN- HR	RPA	10	5000	330.0	12.4	3.3	3.3	1.1	8.0	12.0	Q2

# **PACKAGE MATERIALS INFORMATION**

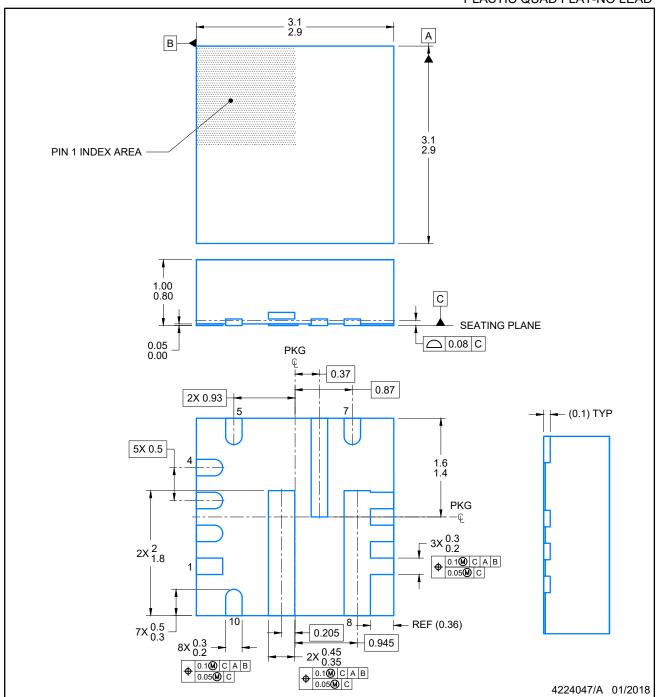
www.ti.com 25-Sep-2024



### \*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TPS56837HARPAR	VQFN-HR	RPA	10	5000	367.0	367.0	35.0
TPS56837HRPAR	VQFN-HR	RPA	10	5000	367.0	367.0	35.0

PLASTIC QUAD FLAT-NO LEAD

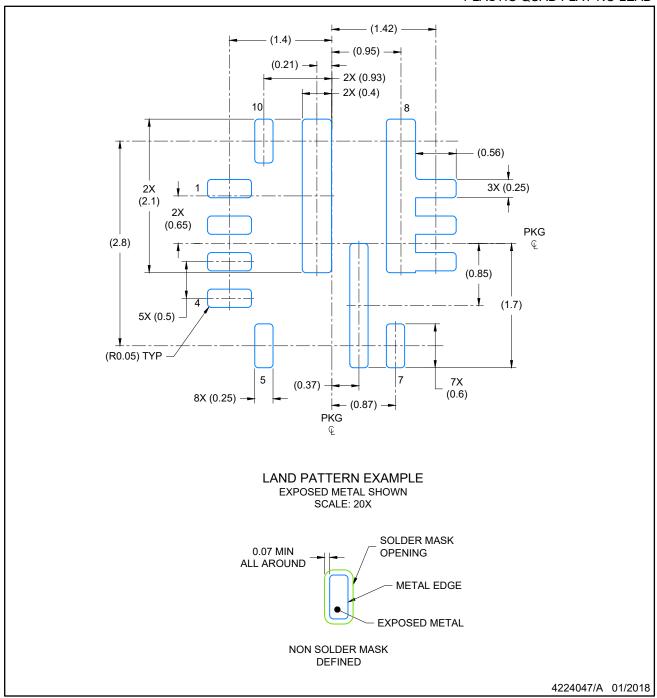


NOTES:

- All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
- 2. This drawing is subject to change without notice.



PLASTIC QUAD FLAT-NO LEAD

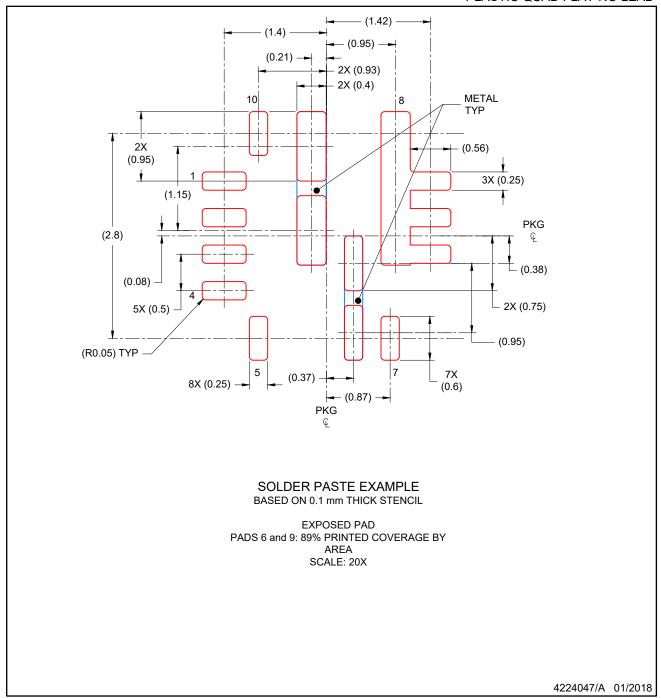


NOTES: (continued)

- 3. For more information, see Texas Instruments literature number SLUA271 (www.ti.com/lit/slua271).
- 4. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



PLASTIC QUAD FLAT-NO LEAD



NOTES: (continued)

5. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

### IMPORTANT NOTICE AND DISCLAIMER

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATASHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, regulatory or other requirements.

These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you fully indemnify TI and its representatives against any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

TI's products are provided subject to TI's Terms of Sale, TI's General Quality Guidelines, or other applicable terms available either on ti.com or provided in conjunction with such TI products. TI's provision of these resources does not expand or otherwise alter TI's applicable warranties or warranty disclaimers for TI products. Unless TI explicitly designates a product as custom or customer-specified, TI products are standard, catalog, general purpose devices.

TI objects to and rejects any additional or different terms you may propose.

Copyright © 2025, Texas Instruments Incorporated

Last updated 10/2025